

## **NCE N-Channel Super Trench II Power MOSFET**

### **Description**

The NCEP18N10AG uses **Super Trench II** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{DS(ON)}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

### **Application**

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

### **General Features**

• V<sub>DS</sub> =100V,I<sub>D</sub> =40A

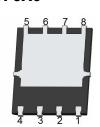
$$\begin{split} R_{DS(ON)} = &15.5 m\Omega \text{ (typical)} \ @ \ V_{GS} = &10 \text{V} \\ R_{DS(ON)} = &19.5 m\Omega \text{ (typical)} \ @ \ V_{GS} = &4.5 \text{V} \end{split}$$

- Excellent gate charge x R<sub>DS(on)</sub> product(FOM)
- Very low on-resistance R<sub>DS(on)</sub>
- 150 °C operating temperature
- Pb-free lead plating

100% UIS TESTED! 100% ΔVds TESTED!

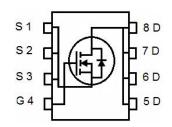
#### **DFN 5X6**





**Top View** 

**Bottom View** 



**Schematic Diagram** 

### **Package Marking and Ordering Information**

<b>Device Marking</b>	Device	Device Package	Reel Size	Tape width	Quantity
P18N10AG	NCEP18N10AG	DFN5X6-8L	-	-	-

### Absolute Maximum Ratings (T<sub>c</sub>=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	VDS	100	V		
Gate-Source Voltage	V <sub>G</sub> s	±20	V		
Drain Current-Continuous	I <sub>D</sub>	40	А		
Drain Current-Continuous(T <sub>C</sub> =100 °C)	I <sub>D</sub> (100℃)	29	Α		
Pulsed Drain Current (Note 1)	I <sub>DM</sub>	160	А		
Maximum Power Dissipation	P <sub>D</sub>	60	W		
Derating factor		0.48	W/℃		
Single pulse avalanche energy (Note 5)	Eas	115	mJ		
Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55 To 150	$^{\circ}$ C		

### **Thermal Characteristic**

Thermal Resistance,Junction-to-Case <sup>(Note 2)</sup>	R <sub>eJC</sub>	2.08	°C/W
Thermal Resistance,Junction-to-Ambient(Note 2)	R <sub>0JA</sub>	55	°C/W

# NCEP18N10AG

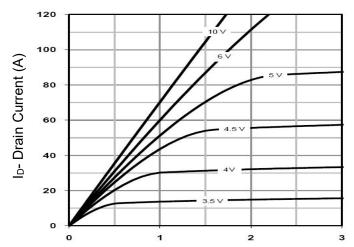
## Electrical Characteristics (T<sub>C</sub>=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	100		-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =100V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS},I_{D}=250\mu A$	1.2	1.7	2.2	V
Desire Source On State Besietenes	Ь	V <sub>GS</sub> =10V, I <sub>D</sub> =20A	-	1.7 15.5 19.5 - 1719.5 147.4 16 28 8 37.6 6.5 9.5	18	mΩ
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =20A	-	19.5	23	mΩ
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =5V,I <sub>D</sub> =20A	20	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C <sub>lss</sub>	V 50V/V 0V	-	1719.5	-	PF
Output Capacitance	Coss	$V_{DS}$ =50V, $V_{GS}$ =0V,	-	147.4	-	PF
Reverse Transfer Capacitance	Crss	F=1.0MHz	-	16	-	PF
Switching Characteristics (Note 4)			•			
Turn-on Delay Time	t <sub>d(on)</sub>		-	14	-	nS
Turn-on Rise Time	t <sub>r</sub>	V <sub>DD</sub> =50V,I <sub>D</sub> =20A	-	16	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10V, $R_{G}$ =3 $\Omega$	-	28	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	8	-	nS
Total Gate Charge	Qg	V 50VI 00A	-	37.6	-	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> =50V,I <sub>D</sub> =20A,	-	6.5		nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =10V	-	9.5		nC
Drain-Source Diode Characteristics	•			- '	-	
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =20A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	40	Α
Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25°C, I <sub>F</sub> = 20A	-	43	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs <sup>(Note3)</sup>	-	90	-	nC

### Notes:

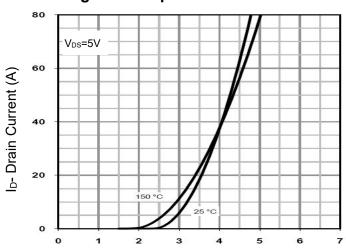
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. The value of  $R_{\theta JA}$  is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with  $T_A$  =25° C. The Power dissipation  $P_{DSM}$  is based on  $R_{\theta JA}$  and the maximum allowed junction temperature of 150° C. The value in any given application depends on the user's specific board design. The  $R_{\theta JA}$  is the sum of the thermal impedance from junction to case  $R_{\theta JC}$  and case to ambient.
- 3. Pulse Test: Pulse Width  $\leq$  300 $\mu$ s, Duty Cycle  $\leq$  2%.
- 4. Guaranteed by design, not subject to production

## **Typical Electrical and Thermal Characteristics**



Vds Drain-Source Voltage (V)





Vgs Gate-Source Voltage (V)
Figure 2 Transfer Characteristics

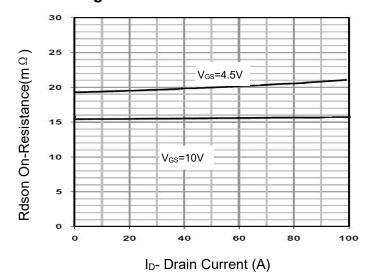
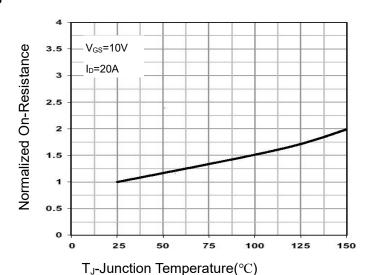


Figure 3 Rdson- Drain Current



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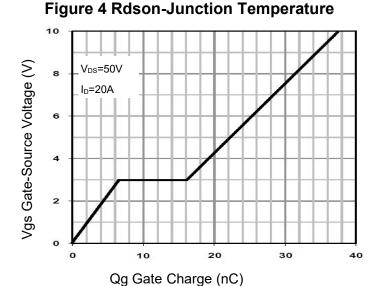
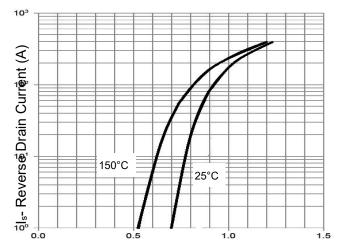
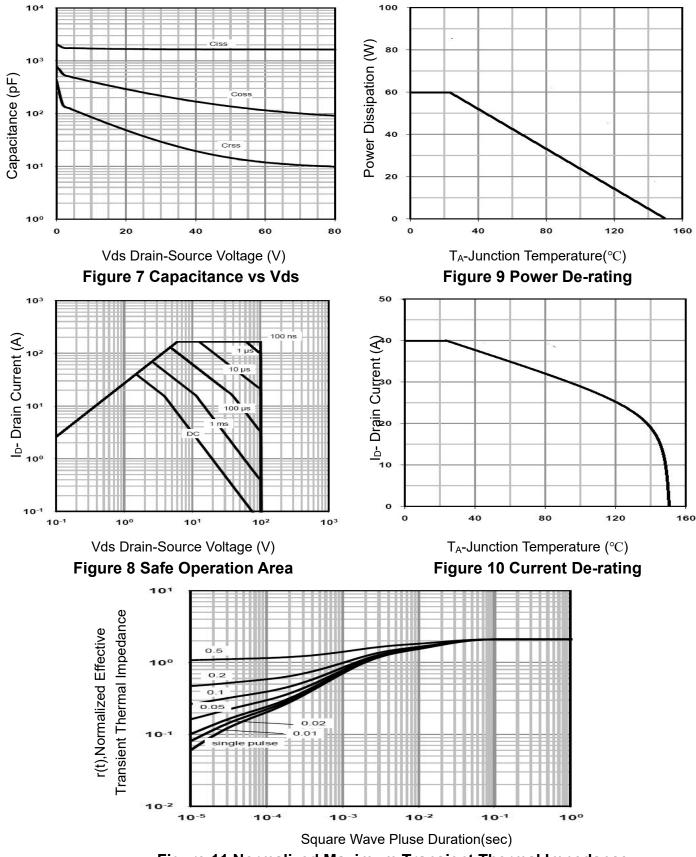


Figure 5 Gate Charge



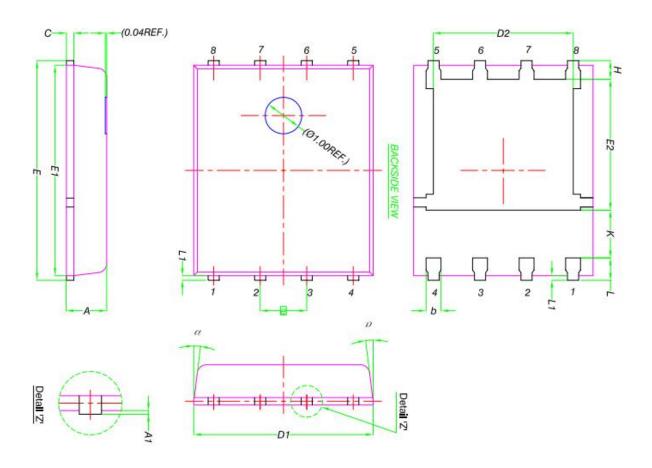
Vsd Source-Drain Voltage (V)

Figure 6 Source- Drain Diode Forward

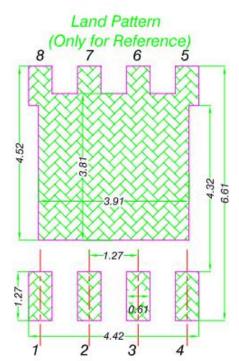


**Figure 11 Normalized Maximum Transient Thermal Impedance** 

## **DFN5X6-8L Package Information**



	MILLIMETERS				
DIM.	MIN.	NOM.	MAX.		
Α	0.90	1.00	1.10		
A1	0	-	0.05		
ь	0.33	0.41	0.51		
С	0.20	0.25	0.30		
D1	4.80	4.90	5.00		
D2	3.61	3.81	3.96		
Ε	5.90	6.00	6.10		
E1	5.70	5.75	5.80		
E2	3.38	3.58	3.78		
е		1.27 BSC			
Н	0.41	0.51	0.61		
K	1.10	-	-		
L	0.51	0.61	0.71		
L1	0.06	0.13	0.20		
α	0°	:	12		



## NCEP18N10AG

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